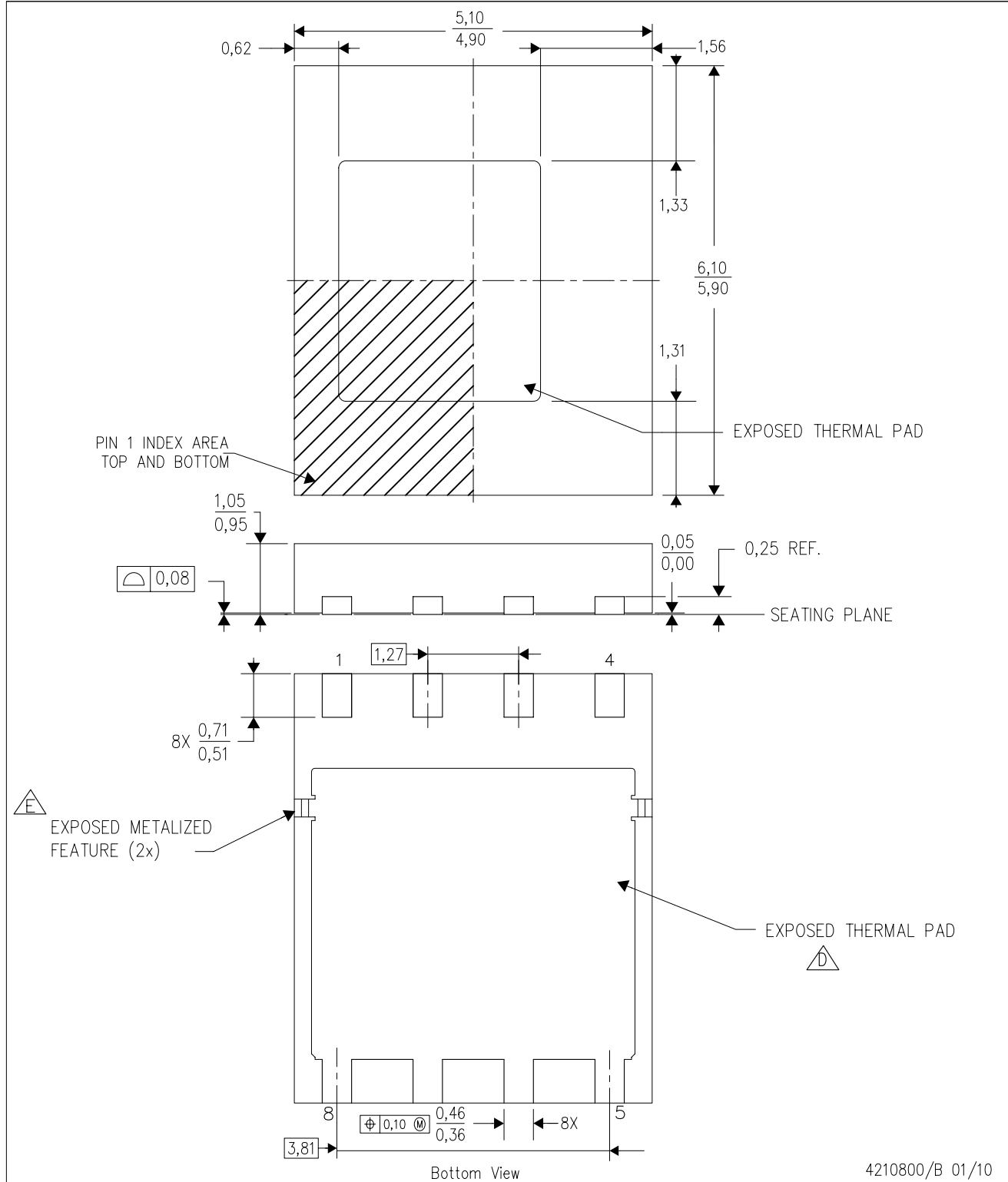


DQU (R-PSON-N8)

PLASTIC SMALL OUTLINE NO-LEAD



4210800/B 01/10

- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - This drawing is subject to change without notice.
 - Dual Cool No-Lead (SON) package configuration.
- ⚠ The package thermal pad must be soldered to the board for thermal and mechanical performance.
- ⚠ Metalized features are supplier options and may not be on the package.

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